

Welcome!

Texas Instruments New Product Update

- This webinar will be recorded and available at www.ti.com/npu
- Phone lines will be muted
- Please post questions in the chat or contact your sales person or field applications engineer

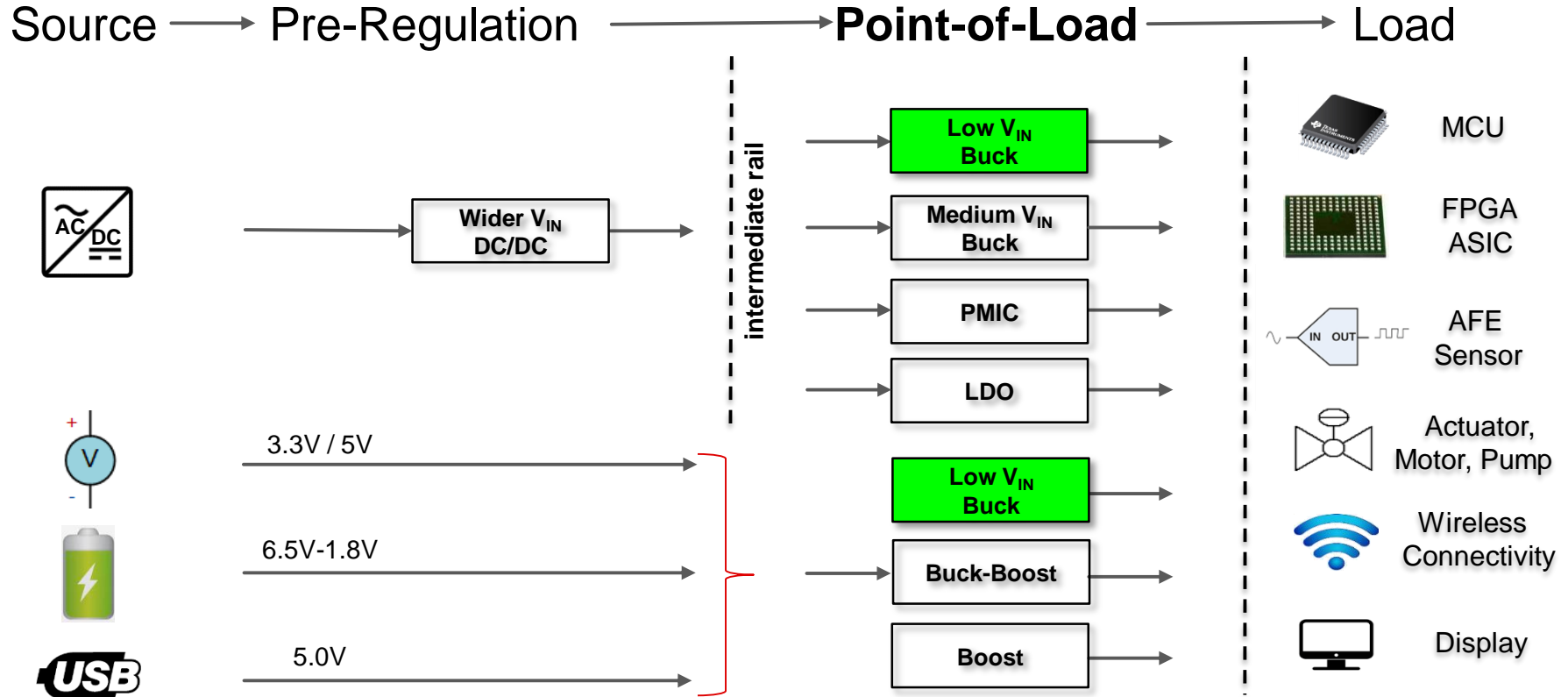
New Product Update: **Low V_{IN} (<7V) Buck (Step Down) DC/DC Converter**

January 14, 2021

Agenda

- **Trends & Solutions**
- New product highlights
 - **FPGA/Processor Core Supply with Dynamic Voltage Scaling**
 - **Point-of-Load solutions in easy-to-use, leaded SOT583 package**
 - **Forced-PWM options with low output voltage ripple**
 - **Modules with integrated inductor: Small, Easy, Cost-Effective**
- Closing remarks & next webinar opportunity

Generic power tree using low V_{IN} buck converter



Low V_{IN} (<7V) buck (step-down) DC/DC converter

Trends & solutions



Processor / FPGA / SoC supply

- Tight Accuracy
- Fast Transient Response
- Dynamic Voltage Scaling

*1% over full Temperature Range, fixed V_{OUT}
DCS-Control Topology
 μ C Interface, V_{SELECT} Function*

Power Density

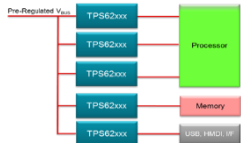
- Multiple Supply Rails
- Thermal Performance
- Small Solution Size
- Quiet Supply

*Pin-compatible families, PowerGood, Sequencing/Tracking
High Efficiency, Power Save Mode, Power Packages
Small packages, small & few external components, easy layout
Fixed Frequency/Sync, Forced-PWM, Spread Spectrum*

Modules

- Ease-to-use, Time-to-market
- Small Solution Size

*Integrated Inductor, integrated C_{IN} , L , C_{OUT}
Embedded Topology (DC/DC below Inductor)*



Low V_{IN} (<7V) buck (step-down) DC/DC converter

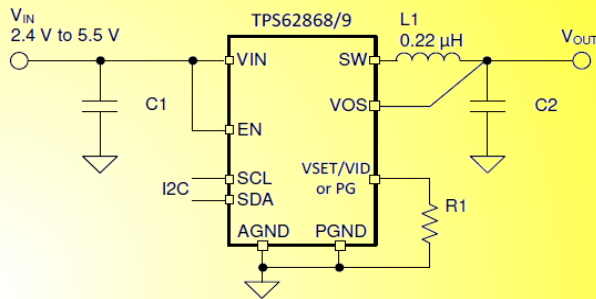
Portfolio highlights

I_{OUT}	High Efficiency & Small Size		Fixed Frequency with f_{sw} synchronization	Ultra Low I_Q nano I_Q	Module Integrated Inductor
	Automatic Power Save	Forced-PWM (option)			
0.3A		TPS62240		TPS62740	TPS82740
0.6A		TPS62230		TPS62840	LMZ10500
		TPS62260			TPS82670
1A	TPS62824 TLV62568	TPS62860 TPS62806 TPS62800	TPS62811		LMZ10501 TPSM82821
2A	TPS62825 TLV62569 TPS62088	TPS62861 TLV62568A TPS62861 TLV62569A	TPS62812 TPS54218		TPS82680 TPS82084 TPSM82822
3A	TPS62826 TLV62585	TPS62826A	TPS62813 TPS54318		TPS82085 TPSM82813
4A	TPS62827 TLV62595	TPS62827A TLV62595A TPS62864 TPS62865	TPS62810 TPS52418		TPSM82810
5A		TPS62868	TPS54519		
6A		TPS62866 TPS62867 TPS62869 TPS62480	TPS54618		TPSM82480
7A			TPS54719		
9A			TPS54917		

Preview products in light teal

TPS62 868 / 869

- V_{IN} : 2.4V to 5.5V
- I_{OUT} : 4A / 6A $R_{DS(on)}$: 11m Ω /10.5m Ω
- V_{OUT} : 0.4V to 1.675V / 5mV steps
- DCS-Control Topology
 - Fast Transient Response
 - Low Ripple Transition to Low Power Mode
- I_Q : 4 μ A
- f_{SW} : 2.4 MHz, L: 220nH
- **1.5 x 2.5 x1mm QFN**
- 1 x 1.8mm WCSP



Your flexible options:

- Selection by external resistor (VSET / VID):
 - Startup output voltage
 - I²C address
- Selection by I²C interface:
 - DVS adjust V_{OUT} 0.4V to 1.675V / 5mV steps
 - Power save mode or Forced-PWM mode
 - Output voltage ramp speed
 - Output discharge
 - Thermal pre-warning protection (130°C)
 - Hiccup or latching short-circuit protection

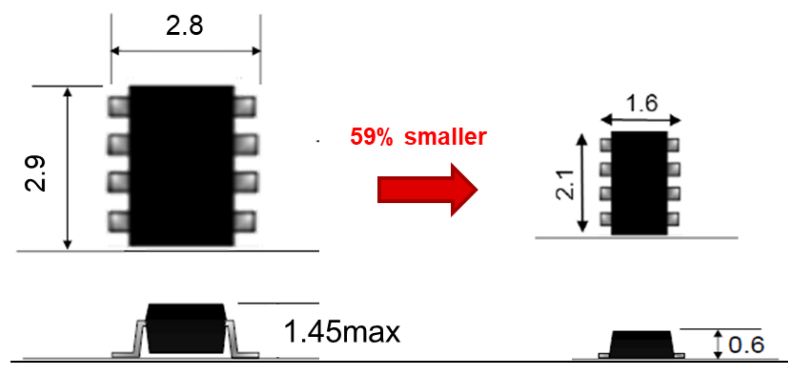
0.6A and 1A bucks w/ I²C interface: TPS62860 and TPS62861

Core supply 4A / 6A with DVS (Dynamic Voltage Scaling)

TPS6286x **NEW**

	Low V_{OUT}	Low V_{OUT}	Ultra-Low V_{OUT}	Mid V_{OUT}
I_{OUT} 6A I_{OUT} 4A	TPS6286 91A/C TPS6286 81A/C	TPS6286 60A/B TPS6286 40A/B	TPS6286 90A/C TPS6286 80A/C	TPS6286 92A/C TPS6286 82A/C
V_{OUT}	0.4V – 1.675V	0.4V – 1.675V	0.2V – 0.8375V	0.8V – 3.35V
Feature	A: VID & I ² C C: PG & I ² C	A: VID & I ² C B: PG/ & I ² C	A: VID & I ² C C: PG & I ² C	A: VID & I ² C C: PG & I ² C
Package	QFN	WCSP	QFN	QFN
Status	Production (C-version in 2Q21)	Production	Samples: 1Q'21 RTM: 2Q'21	Samples: 1Q'21 RTM: 2Q'21

↑
LPDDR5
Memory



SOT23-8

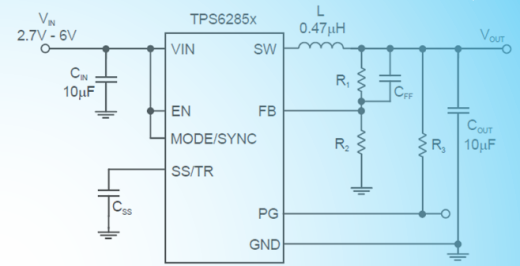
Package size: 8.1mm²

SOT583

Package size: 3.4mm²

TPS62 850 / 851

- V_{IN} : 2.7V to 6.0V
- I_{OUT} : 0.5A, 1A, 2A
- V_{OUT} : 0.6V to 5.5V
- Accuracy: 1% (-40 to +150°C T_J)
- **Fixed Frequency** (sync 1.8-4MHz)
- **Selectable MODE: F-PWM / PSM**
- I_Q : 15 μ A
- L: 470nH, C_{OUT} : 2x10 μ F
- **1.6 x 2.1mm SOT583**



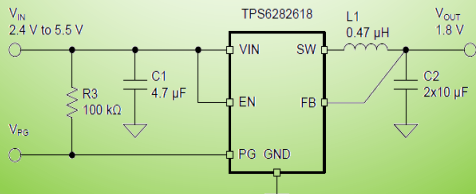
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	<u>Adjustable Softstart</u>	<u>Selectable Compensation</u>
0.5A	TPS628510	
1A	TPS628511	TPS628501
2A	TPS628512	TPS628502

Functional safety capable: documentation available on www.ti.com for FIT rate, Failure mode distribution, Pin-FMA

TPS62 82x

- V_{IN} : 2.4V to 5.5V
- I_{OUT} : 1A, 2A, 3A, 4A
- $R_{SD(on)}$: 26m Ω / 25m Ω , up to 97% η
- V_{OUT} : 0.6V to 4V
- Accuracy: 1% (-40 to +125°C T_J)
- DCS-Control™ Topology
- I_Q : 4 μ A
- f_{SW} : 2.2 MHz
- L: 470nH, C_{OUT} : 2x10 μ F
- **1.5 x1.5mm QFN** (2A,3A,4A) 31mm²
- 2 x 2.5 x 1.2mm TPSP8282x 25mm²



Forced-PWM

TPS62 82xA (1.5x1.5mm)

1A family extension

1A / 2A / 3A / 4A
family extension

Automatic Power Save Mode

1A	TPS62824
2A	TPS62825
3A	TPS62826
4A	TPS62827

Forced-PWM Mode

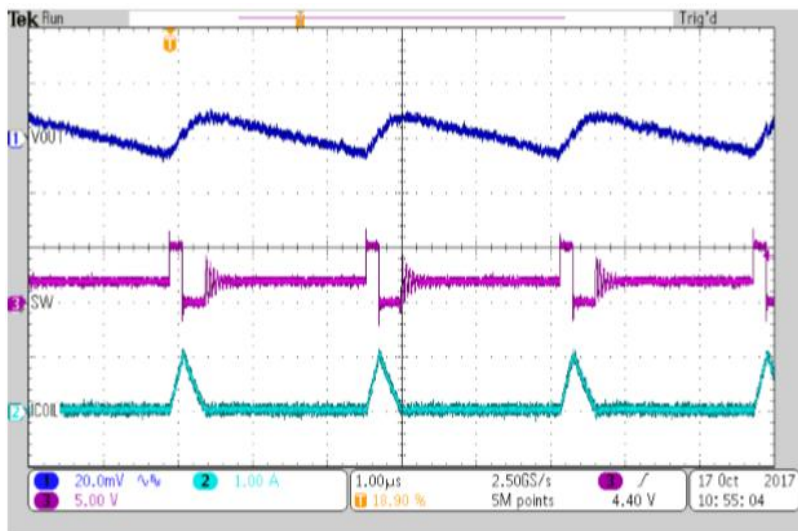
TPS62824A
TPS62825A
TPS62826A
TPS62827A

Forced-PWM family extension, pin-2-pin QFN (1A-4A)

TPS6282x **NEW**

TPS6282x in Power Save Mode

$V_{OUTrippl} \sim 10\text{mV} @ 0.1\text{A}_{OUT}$

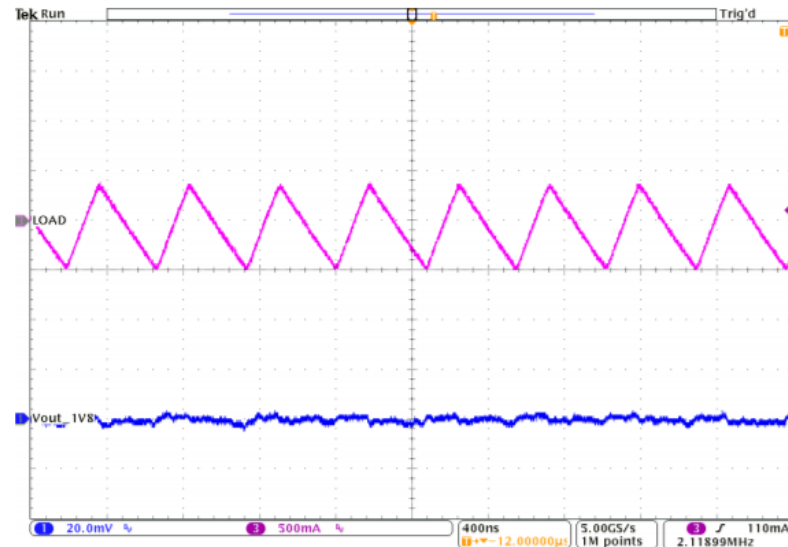


$C_{OUT}=2 \times 10\mu\text{F}$

$I_{OUT}=0.1\text{A}$

TPS6282xA in Forced-PWM Mode

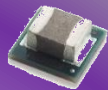
$V_{OUTrippl} \sim 3\text{mV} @ \text{no load}_{OUT}$



Modules (internal inductor) with very high power density (1A-4A) TPSM828xx

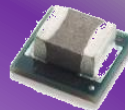
NEW

TPSM82 82x



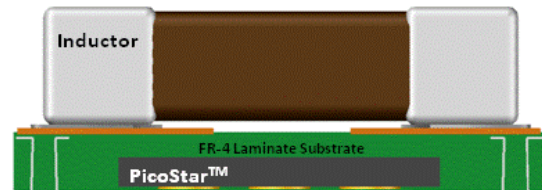
- **2 x 2.5 x 1mm**
- **Integrated Inductor**
- V_{IN} : 2.4V to 5.5V
- **I_{OUT} : 1A / 2A**
- V_{OUT} : 0.6V to 4V (and fixed V_{OUT})
- Accuracy: 1% (-40 to +125°C T_J)
- Efficiency: up to 95%
- I_Q : 4 μ A
- DCS-Control Topology
 - Fast transient response
 - Low ripple transition to low power

TPSM82 81x



- **3 x 4 x 2.3mm**
- **Integrated Inductor**
- V_{IN} : 2.7V to 6.0V
- **I_{OUT} : 3A, 4A**
- V_{OUT} : 0.6V to 5.5V
- Accuracy: 1% (-40 to +125°C T_J)
- Efficiency: up to 97%
- I_Q : 15 μ A
- Peak current mode topology
 - Adjustable frequency (1.8-4MHz)
 - Synchronizable
 - Forced-PWM mode
 - Selectable compensation
 - Adjustable soft start
 - Tracking/sequencing
 - Optional spread spectrum

Cross-section of embedded DC/DC converter modules



- **Very small solution size**
- **Standard reflow manufacturing capable**
- **Superior EMI and Noise performance**

System-in-Package integrates the IC inside a printed circuit board (laminated substrate) with SMD components on top. High volume production using this packaging technology was started at Texas Instruments in 2010.

Low V_{IN} (<7V) buck (step-down) DC/DC converter

New product update

TPS62 80x *Small solution size down to 0.7x1mm chip scale package*

TPS62 81x *Automotive qualified 1A – 4A output*

TPS62 82x *High efficiency, low $R_{DS(on)}$, w/wo Forced-PWM 1A – 4A*

TPS62 84x *Ultra-Low I_Q down to 60nA operating*

TPS62 85x *Point-of-Load with Forced-PWM in SOT583 package*

TPS62 86x *Core supply with Dynamic Voltage Scaling 0.6A – 6A*

TPSM82 8xx *Easy, small, cost-effective module with integrated inductor*

Visit www.ti.com/npu

For more information on the New Product Update series, calendar and archived recordings



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